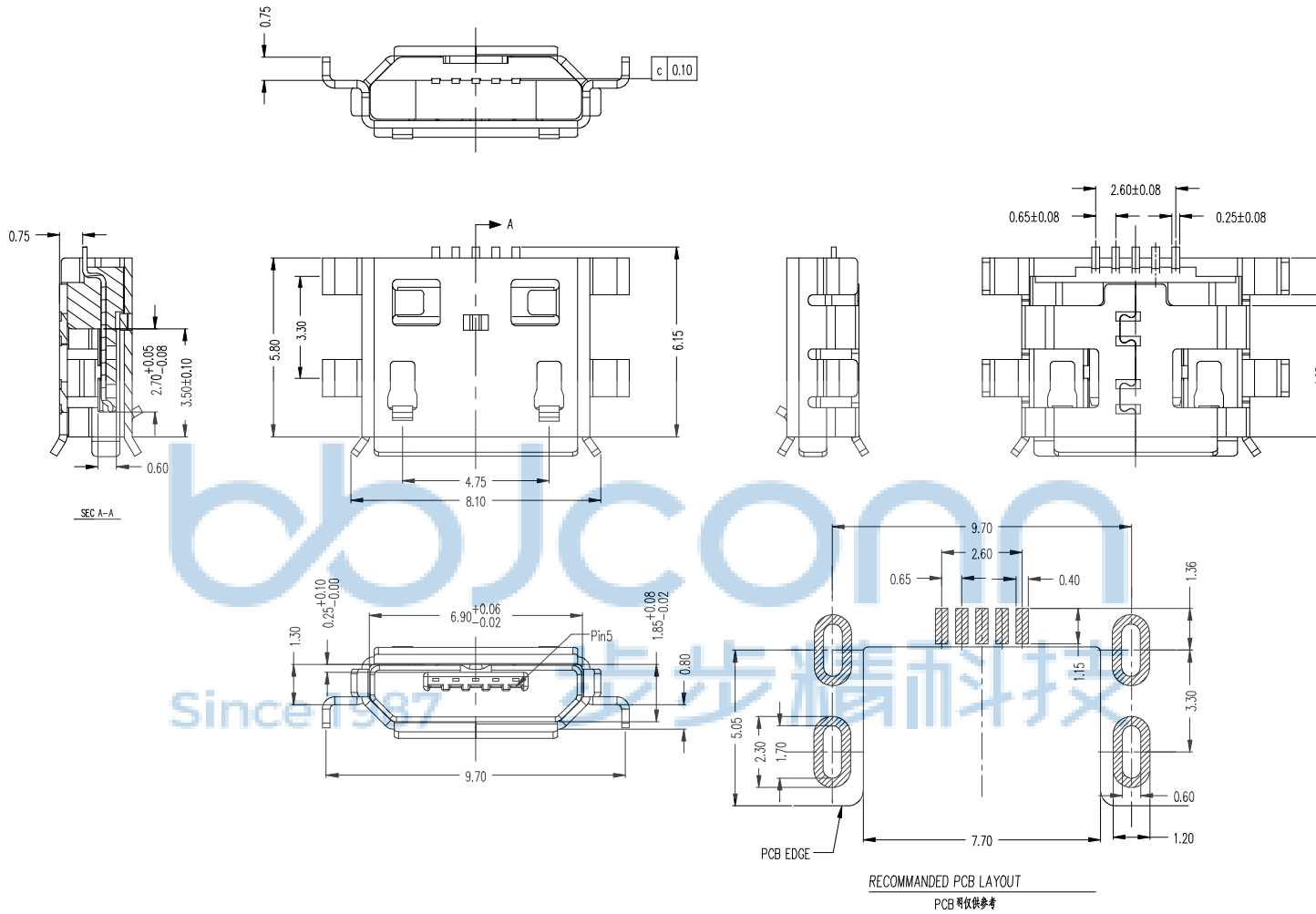


REV.	ECN NO	CONTENT	DATE	ENGINEER
AO			2023 20/04	



Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: SUS/copper alloy,t=0.25mm

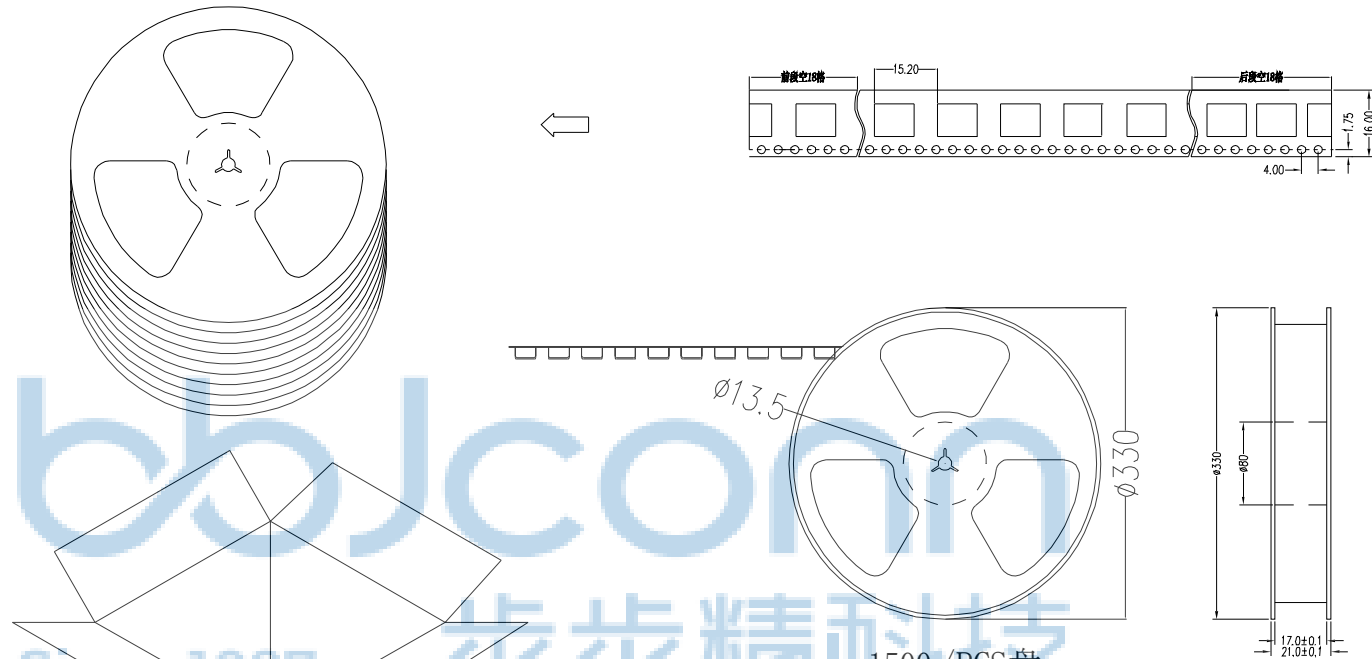
2.Specification:

- 2.1 Current rating: 1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kg Max.
- 2.6 Total unmating force: 1.0 Kg Min.
- 2.7 Temperature range: -30°C~80°C



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APPD.	JM_Zheng	23/05'02	PJ. NO.: MC.01.71-21-1001		
CHKD.	LYX	23/05'02	SIZE: A4   DRW NO.:		
PDWG.NO:	0113-1	DR.	SGF	23/05'02	FINISH: SEE NOTES    MAT'L.: SEE NOTES SCALE: N/A    REV.: A3    UNIT: mm    PAGE: 1/1

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0			2023 20/04	



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备注：  
 1. 包装数量：1500 /PCS/盘，10盘/箱或15盘/箱。  
 2. 包装袋长度：每盘前后各空10-20个空格，中间包装。  
 3. 材质：  
 载体：聚丙烯（PS），阻抗 $10^{6-9} \Omega$   
 上带：聚乙烯（PET），阻抗 $10^{6-11} \Omega$   
 卷盘：聚苯乙烯。  
 纸箱规格：345\*345\*23MM  
 纸箱规格：345\*345\*35MM



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PDWG.NO: 0113-1	DR.	SGF	23/05/02	SCALE: N/A	REV.: A3
			UNIT: mm	PAGE: 1/1	